

SID

Factory: Rot am See

Article:

ML6

Provided:

Customer:

Date:

03.04.2026

WÜRTH
ELEKTRONIK
MORE THAN
YOU EXPECT

Processtechnology: B: undefined

Material Text	Mat. Nr.	µm	Stackup	Process overview
A-RS Kupferfolie-070my 330x490mm	50200246	70	VS	1
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	425		2
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	0		3
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		4
		105	L2	
C-RaS-FR4-ML-0.711mm-105+105-TG150-HF...	50203137	710		5
		105	L3	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	50		6
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	205		7
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		8
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	50		9
		105	L4	
C-RaS-FR4-ML-0.711mm-105+105-TG150-HF...	50203137	710		10
		105	L5	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	425		11
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	0		12
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	0		13
A-RS Kupferfolie-070my 330x490mm	50200246	70	RS	14

Thickness after Pressing

B00:

3090 µm

Tol+:

320 µm

Tol-:

320 µm

Dmax:

3410 µm

Dmin:

2770 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

3200 µm

Tol+:

320 µm

Tol-:

320 µm

Dmax:

3520 µm

Dmin:

2880 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal:

3135 µm

Version 1.2.20.35

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